

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Hengchun Mao</td><td>06/08/2011</td></tr><tr><td>Dianbo Fu</td><td>06/08/2011</td></tr><tr><td>Bing Cai</td><td>06/08/2011</td></tr></tbody></table>	Name	Execution Date	Hengchun Mao	06/08/2011	Dianbo Fu	06/08/2011	Bing Cai	06/08/2011	
Name	Execution Date								
Hengchun Mao	06/08/2011								
Dianbo Fu	06/08/2011								
Bing Cai	06/08/2011								
RECEIVING PARTY DATA									
Name:	FutureWei Technologies, Inc.								
Street Address:	5340 Legacy Drive								
Internal Address:	Suite 175								
City:	Plano								
State/Country:	TEXAS								
Postal Code:	75024								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13156203</td></tr></tbody></table>	Property Type	Number	Application Number:	13156203					
Property Type	Number								
Application Number:	13156203								
CORRESPONDENCE DATA									
Fax Number:	(972)732-9218								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone:	(972)732-1001								
Email:	white@slater-matsil.com								
Correspondent Name:	Slater & Matsil, L.L.P.								
Address Line 1:	17950 Preston Road								
Address Line 2:	Suite 1000								
Address Line 4:	Dallas, TEXAS 75252								
ATTORNEY DOCKET NUMBER:	HW83157683US								
NAME OF SUBMITTER:	Lauran M. White								
Total Attachments: 1 source=Assignment#page1.tif									

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PATENT
REEL: 026732 FRAME: 0416

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and


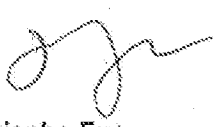
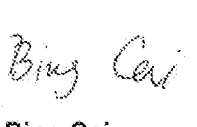
WHEREAS, FutureWei Technologies, Inc. ("FutureWei"), a corporation organized and existing under the laws of Texas, with its principal office at 5340 Legacy Drive, Suite 175, Plano, TX 75024, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said FutureWei, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said FutureWei, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to FutureWei, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said FutureWei, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said FutureWei, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Power Converter Package Structure and Method			
SIGNATURE OF INVENTOR AND NAME	 Hengchun Mao	 Dianbo Fu	 Bing Cai	
DATE	6/8/2011	6/08/2011	6/8/2011	
RESIDENCE (City, State)	Plano, TX	Richardson, TX	Richardson, TX	